Simulation of elastic strain in electron shuttling devices I. Zaitsev IHP – Leibniz-Institut für innovative Mikroelektronik

Si/Sige BASED SPIN QUBITS

30 nm 10 nm 10 nm 10 nm **TiN QuBus**

Jeo of

Si_{0.34}Ge_{0.66} buffer

barrier

The realization of error-corrected quantum processors will require interconnected arrays of > 10⁴ qubits.

- Communication between qubits must be established by e.g. coherent electron shuttling [1], that can be realized with the quantum bus architecture [2].
- Gate operation voltages and shuttling are affected by the local band energy level, which, in turn, depends on the lattice strain in the quantum well





Maps of the TiN K-edge fluorescence and the strain tensor components in the quantum well

METHODS

SXDM

 X-ray nanoprobe beamline ID01/ESRF [1] produces microscopic maps of the lattice strains induced by TiN electrodes deposited



FEM modeling

Analysis of mechanical deformations by means of Hooke's law ($\sigma_{ij} = C_{ijkl} \varepsilon_{kl}$) in Si/SiGe qubit devices stressed by TiN electrodes.



on the top surface of two Si/SiGe quantum well samples grown on Si(001) substrates.

Calculation of the changes in the band structure using the k·p method.

The reproduction of the periodic TiN electrodes on the Si/Si_{0.7}Ge_{0.3} heterostructure.

FEM SIMULATIONS AND COMPARISON WITH SXDM



Comparison of the measured strain components and the conduction band edge calculated from them. The areas directly under the electrodes are marked green. The electrode-driven strain fluctuations can be seen to be roughly two times greater for the sample with stronger initial stress in TiN.

Conclusions and outlook

For the Si quantum well, the calculated strain variation Δa/a due to TiN electrodes of several 10⁻⁴ is confirmed by XRD measurements.

Open question: what is the strain landscape at cryogenic quantum operation temperature?

- Conduction band calculations are expected to be within several meV (comparable to quantum dot charging energy).
- Agreement with variation expected from Park et al. (1.4 meV per 10⁻⁴) [6].
- After benchmarking, our model can be utilized for strain engineering tailored towards functional quantum devices (Qubits, QuBus)

References

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